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February 1997 Revised August 2004

NC7ST00

TinyLogic® HST 2-Input NAND Gate

General Description

The NC7ST00 is a single 2-Input high performance CMOS NAND Gate, with TTL-compatible inputs. Advanced Silicon Gate CMOS fabrication assures high speed and low power circuit operation. ESD protection diodes inherently guard both inputs and output with respect to the $V_{\rm CC}$ and GND rails. High gain circuitry offers high noise immunity and reduced sensitivity to input edge rate. The TTL-compatible inputs facilitate TTL to NMOS/CMOS interfacing. Device performance is similar to MM74HCT but with 1/2 the output current drive of HC/HCT.

Features

- Space saving SOT23 or SC70 5-lead package
- Ultra small MicroPak™ leadless package
- High Speed; t_{PD} < 7 ns typ, V_{CC} = 5V, C_L = 15 pF
- \blacksquare Low Quiescent Power; $I_{CC} < 1~\mu\text{A}$ typ, $V_{CC} = 5.5 V$
- Balanced Output Drive; 2 mA I_{OL}, -2 mA I_{OH}
- TTL-compatible inputs

Ordering Code:

Order Number	Package Number	Product Code Top Mark	Package Description	Supplied As
NC7ST00M5X	MA05B	8S00	5-Lead SOT23, JEDEC MO-178, 1.6mm	3k Units on Tape and Reel
NC7ST00P5X	MAA05A	T00	5-Lead SC70, EIAJ SC-88a, 1.25mm Wide	3k Units on Tape and Reel
NC7ST00L6X	MAC06A	E3	6-Lead MicroPak, 1.0mm Wide	5k Units on Tape and Reel

Logic Symbol



Pin Descriptions

Pin Names	Description
A, B	Inputs
Y	Output
NC	No Connect

Function Table

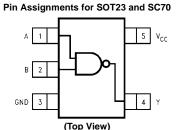
$$Y = \overline{AB}$$

Inp	Output	
Α	Y	
L	L	Н
L	Н	Н
Н	L	Н
Н	Н	L

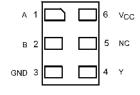
H = HIGH Logic Level L = LOW Logic Level

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Connection Diagrams



Pad Assignments for MicroPak



(Top Thru View)

Absolute Maximum Ratings(Note 1)

Recommended Operating Conditions (Note 2)

 $\begin{array}{ccc} V_{IN} < -0.5 \text{V} & -20 \text{ mA} \\ V_{IN} \geq V_{CC} + 0.5 \text{V} & +20 \text{ mA} \\ \text{DC Input Voltage V}_{IN} & -0.5 \text{V to V}_{CC} + 0.5 \text{V} \\ \end{array}$

DC Output Diode Current (I_{OK})

$$\begin{split} & V_{\text{OUT}} < -0.5 \text{V} & -20 \text{ mA} \\ & V_{\text{OUT}} > V_{\text{CC}} + 0.5 \text{V} & +20 \text{ mA} \end{split}$$

Output Voltage (V_{OUT}) -0.5V to $V_{CC} + 0.5V$

DC Output Source or

Sink Current (I_{OUT}) $\pm 12.5 \text{ mA}$

DC V_{CC} or Ground Current per

Supply Pin (I_{CC} or I_{GND}) ± 25 mA Storage Temperature (T_{STG}) -65°C to $+150^{\circ}\text{C}$

Junction Temperature (T_J) 150°C

Lead Temperature (T_L);

(Soldering, 10 seconds) 260°C

Power Dissipation (PD) @ +85°C

SOT23-5 200 mW SC70-5 150 mW Input Rise and Fall Time (t_r, t_f)

 $V_{CC} = 5.0V$ 0 to 500 ns

Thermal Resistance (θ_{JA})

SOT23-5 300°C/W

SC70-5 425°C/W

Note 1: Absolute Maximum Ratings are those values beyond which damage to the device may occur. The databook specifications should be met, without exception, to ensure that the design is reliable over its power supply, temperature, and output/input loading variables Fairchild does not recommend operation of circuits outside the databook specifications.

Note 2: Unused inputs must be held HIGH or LOW. They may not float.

DC Electrical Characteristics

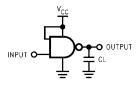
Symbol	Parameter	v _{cc}	$T_A = +25^{\circ}C$			$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$		Units	Conditions	
Symbol	Farameter	(V)	Min	lin Typ Max		Min	Max	Ullits	Conditions	
V _{IH}	HIGH Level Input Voltage	4.5-5.5	2.0			2.0		V		
V _{IL}	LOW Level Input Voltage	4.5-5.5			8.0		0.8	V		
V _{OH}	HIGH Level Output Voltage	4.5	4.4	4.5		4.4			$I_{OH} = -20 \mu A$	
		4.5	4.18	4.35		4.13		V	$I_{OH} = -2 \text{ mA}$	
									$V_{IN} = V_{IL}$	
V _{OL}	LOW Level Output Voltage	4.5		0	0.1		0.1		$I_{OL} = 20 \mu A$	
		4.5		0.10	0.26		0.33	V	I _{OL} = 2 mA	
									$V_{IN} = V_{IH}$	
I _{IN}	Input Leakage Current	5.5			±0.1		±1.0	μΑ	$0 \le V_{IN} \le 5.5V$	
I _{CC}	Quiescent Supply Current	5.5			1.0		10.0	μΑ	$V_{IN} = V_{CC}$ or GND	
I _{CCT}	I _{CC} per Input	5.5			2.0		2.9	mA	One Input $V_{IN} = 0.5V$ or 2.4V,	
									Other Input V _{CC} or GND	

AC Electrical Characteristics

Symbol	Parameter	v _{cc}	T _A = +25°C			$T_A = -40^{\circ}C$ to $+85^{\circ}C$		Units	Conditions	Figure
Cyllibol	i arameter	(V)	Min Typ		Max	Min			Conditions	Number
t _{PLH} ,	Propagation Delay	5.0		3.4	12				C _I = 15 pF	
t _{PHL}				6.3	17				CL = 15 pr	
				6.0	16		20	ns		Figures
				11.5	27		31	115	C ₁ = 50 pF	1, 3
				4.1	14		18		CL = 50 pr	
				11.2	26		30			
t _{TLH} ,	Output Transition Time	5.0		4	10			ns	C _L = 15 pF	<u>-</u> .
t_{THL}		4.5		11	25		31	ns	C _L = 50 pF	Figures 1, 3
		5.5		10	21		26	113		, -
C _{IN}	Input Capacitance	Open		2	10			pF		
C _{PD}	Power Dissipation Capacitance	5.0		6				pF	(Note 3)	Figure 2

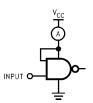
Note 3: C_{PD} is defined as the value of the internal equivalent capacitance which is derived from dynamic operating current. Current consumption (I_{CCD}) at no output loading and operating at 50% duty cycle. (See Figure 2). CPD is related to I_{CCD} dynamic operating current by the expression: $I_{CCD} = (C_{PD})(V_{CC})(f_{|N}) + (I_{CCStatic}).$

AC Loading and Waveforms



 ${
m C_L}$ includes load and stray capacitance Input PRR = 1.0 MHz; ${
m t_W}$ = 500 ns

FIGURE 1. AC Test Circuit



$$\label{eq:problem} \begin{split} & \text{Input} = \text{AC Waveform; PRR} = \text{variable; Duty Cycle} = 50\% \\ & \qquad \qquad \text{FIGURE 2. } I_{\text{CCD}} \text{ Test Circuit} \end{split}$$

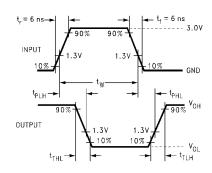


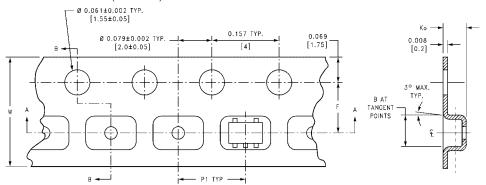
FIGURE 3. AC Waveforms

Tape and Reel Specification

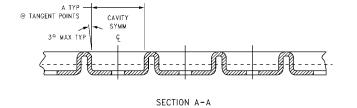
TAPE FORMAT

Package	Tape	Number	Cavity	Cover Tape
Designator	Section	Cavities	Status	Status
	Leader (Start End)	125 (typ)	Empty	Sealed
M5X, P5X	Carrier	3000	Filled	Sealed
	Trailer (Hub End)	75 (typ)	Empty	Sealed

TAPE DIMENSIONS inches (millimeters)



DIRECTION OF FEED SECTION B-B

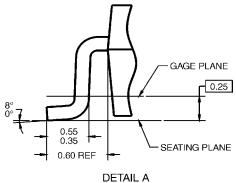




BEND RADIUS NOT TO SCALE

Package	Tape Size	DIM A	DIM B	DIM F	DIM K _o	DIM P1	DIM W
SC70-5	8 mm	0.093	0.096	0.138 ± 0.004	0.053 ± 0.004	0.157	0.315 ± 0.004
		(2.35)	(2.45)	(3.5 ± 0.10)	(1.35 ± 0.10)	(4)	(8 ± 0.1)
SOT23-5	8 mm	0.130	0.130	0.138 ± 0.002	0.055 ± 0.004	0.157	0.315 ± 0.012
		(3.3)	(3.3)	(3.5 ± 0.05)	(1.4 ± 0.11)	(4)	(8 ± 0.3)

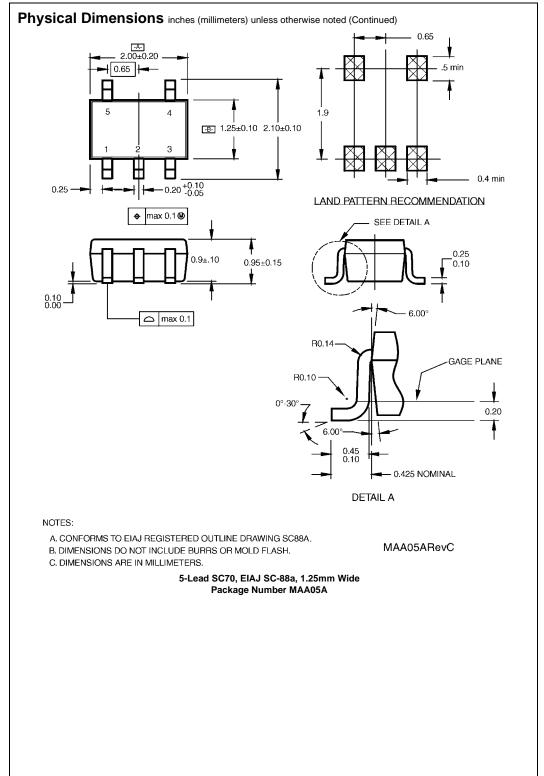
Tape and Reel Specification (Continued) TAPE FORMAT for MicroPak Package Tape Number Cavity Cover Tape Designator Section Cavities Status Status Leader (Start End) 125 (typ) Empty Sealed L6X Carrier 5000 Filled Sealed Trailer (Hub End) 75 (typ) **Empty** Sealed 4.00 1.75±0.10 В-8.00 +0.30 3.50±0.05 9 0.50 ±0.05 SECTION B-B DIRECTION OF FEED-SCALE:10X 0.254±0.020 r 0.70±0.05 SECTION A-A SCALE:10X **REEL DIMENSIONS** inches (millimeters) TAPE SLOT DETAIL X **DETAIL X** SCALE: 3X W1 W3 Tape В W2 Size 7.0 0.059 0.512 0.795 2.165 0.331 + 0.059/-0.000 0.567 W1 + 0.078/-0.039 8 mm (8.40 + 1.50/-0.00) (W1 + 2.00/-1.00)(177.8)(1.50)(13.00)(20.20)(55.00)(14.40)



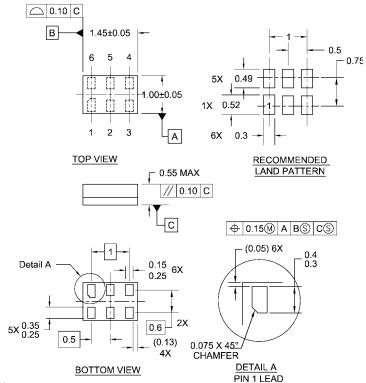
- DATED JANUARY 1999.
- B) ALL DIMENSIONS ARE IN MILLIMETERS.

MA05BRevC

5-Lead SOT23, JEDEC MO-178, 1.6mm Package Number MA05B



Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



Notes:

- 1. JEDEC PACKAGE REGISTRATION IS ANTICIPATED 2. DIMENSIONS ARE IN MILLIMETERS
- 3. DRAWING CONFORMS TO ASME Y14.5M-1994

MAC06ARevB

6-Lead MicroPak, 1.0mm Wide Package Number MAC06A

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